ES51993<br>11，000 Counts ADC

## Features

－Max．11，000 counts resolution
－Conversion rate selectable by MPU command：1．6／s $\rightarrow$ 128／s
－Input signal full scale： 110 mV
－ $50 / 60 \mathrm{~Hz}$ line noise rejection selectable by MPU command
－Low battery detection
－Multiple input channels for ADC
－3－wire serial bus and EOC signal for MPU I／O port
－-3 V power operation with internal charge pumping circuit
－MPU I／O power level selectable by external control pin
－Support Peak Hold with calibration mode
－Zero calibration for eliminating offset error
－On－chip buzzer driving and frequency selectable by MPU command
－Support sleep mode by external CS（chip－ select）pin

## Description

ES51993 is an 11000－count dual－slope analog－ to－digital converter（ADC）with peak hold function．The conversion rate and buzzer frequency can be selected or decided by an external microprocessor．The conversion rate can be varied from 1.6 time $/ \mathrm{sec}$ to 128 times／sec under $4 \mathrm{MHz} / 12 \mathrm{MHz}$ crystal oscillation clock．Besides，ES51993 also provides multi－channel input，low battery detection，power－down mode， $50 / 60 \mathrm{~Hz}$ line noise rejection selection，and I／O port level selection for flexible design．

## Application

Clamp meter
Thermometer
Portable instrumentation

## Pin Assignment

LQFP－32L


## Pin Description

| Pin No | Symbol | Type | Description |
| :---: | :---: | :---: | :---: |
| 1 | CAZ | I | Auto－zero capacitor connection． |
| 2 | CINT | O | Integrator output．Connect to integral capacitor |
| 3 | CREF＋ | I／O | Positive connection for reference capacitor． |
| 4 | CREF－ | I／O | Negative connection for reference capacitor． |
| 5 | REF＋ | I | Differential reference high voltage input． |
| 6 | REF－ | I | Differential reference low voltage input． |
| 7 | BUF | O | Buffer output pin．Connect to integral resistor |
| 8 | RAZ | O | Buffer output pin in high－speed mode．Connect to high－speed integral resistor． |
| 9 | PHin | I | Pick hold signal input which is reference to AGND |
| 10 | PMAX | O | Minimum peak hold output capacitor connection． |
| 11 | PMIN | O | Maximum peak hold output capacitor connection． |
| 12 | VIN＋ | I | Analog differential high signal input． |
| 13 | VIN1＋ | I | Analog signal high input1 |
| 14 | VIN2＋ | I | Analog signal high input2 |
| 15 | VIN－ | I | Analog differential low signal input． |
| 16 | SDATA | I／O | Serial data I／O pin．Nch open－drain output． |
| 17 | SCLK | I | Serial clock input pin． |
| 18 | EOC | O | An indicator for ADC conversion ending． |
| 19 | BUZOUT | O | Buzzer frequency output |
| 20 | uP＿VCC | I | MPU I／O port power level selection |
| 21 | OSC2 | O | Crystal oscillation connection |
| 22 | OSC1 | I | Crystal oscillation connection |
| 23 | C－ | O | Negative capacitor connection for on－chip DC－DC converter． |
| 24 | C＋ | O | Positive capacitor connection for on－chip DC－DC converter． |
| 25 | CS | I | Chip select input pin．Pull to Low to enter power down mode． |
| 26 | I／O＿control | I | MPU I／O port ground level selection |
| 27 | LBAT | I | Low battery configuration．If 3 V battery is used，connect it to AGND． The default low－battery threshold voltage is -2.3 V ．If 9 V or other battery voltage is used，the low battery annunciator is displayed when the voltage of this pin is less than V12 |
| 28 | DGND | G | Digital ground |
| 29 | V＋ | O／P | Output of on－chip DC－DC converter． |
| 30 | V－ | P | Negative supply voltage．Connecting to 3V battery negative terminal． |
| 31 | AGND | G | Analog ground |
| 32 | V12 | O | Output of band－gap voltage reference．Typically -1.23 V |

## Function description

## 1．Dual Slope A／D－Four Phases Timing

ES51993 is a dual－slope analog－to－digital converter（ADC）．Figure 1 is a structure of dual－slope integrator．Its measurement cycle has two distinct phases：input signal integration（INT）phase and reference voltage integration（DINT）phase．

In INT phase，the input signal is integrated for a fixed time period，then A／D enters DINT phase in which an opposite polarity constant reference voltage is integrated until the integrator output voltage becomes to zero．Since both the time period for input signal integration and the amount of reference voltage are fixed，thus the de－integration time is proportional to the input signal．Hence，we can define the mathematical equation about input signal，reference voltage integration（see Figure 1．）：

$$
\frac{1}{B u f \times C \text { int }} \int_{0}^{T_{N T}} V_{I N}(t) d t=\frac{1}{B u f \times C \text { int }} \times V_{R E F} \times T_{D I N T}
$$

where，$V_{I N}(t)=$ input signal
$V_{R E F}=$ reference voltage
$T_{I N T}=$ integration time（fixed）
$T_{D I N T}=$ de－integration time（proportional to $V_{I N}(t)$ ）


Figure 1．the structure of dual－slope integrator and its output waveform．
If $V_{I N}(t)$ is a constant，we can rewrite above equation：

$$
T_{D I N T}=\frac{T_{I N T}}{V_{R E F}} \times V_{I N}
$$

Besides the INT phase and DINT phase，ES51993 exploits auto zero（AZ）phase and zero integration（ZI）phase to achieve accurate measurement．In AZ phase，the system offset is stored．The offset error will be eliminated in DINT phase．Thus a higher accuracy could be obtained．In ZI phase，the internal status will be recovered quickly to that of zero input．Thus the succeeding measurements won＇t be disturbed by current measurement especially in case of overload．

As mentioned above，the measurement cycle of ES51993 contains four phases：
（1）auto zero phase（AZ）
（2）input signal integration phase（INT）
（3）reference voltage integration phase（DINT）
（4）zero integration phase（ZI）
The time ratios of these four phases，AZ，INT，DINT and ZI to the entire measurement cycle are $8.8 \%, 32 \%, 35.2 \%$ and $24 \%$ respectively．However the actual duration of each phase depends on conversion rate．An example is shown in the table below．A user can easily deduce other cases based on the table．

Voltage：

| CR（times／sec） | ZI（ms） | AZ（ms） | INT（ms） | DINT（ms） |
| :---: | :---: | :---: | :---: | :---: |
| $\mathbf{8}$ | $\mathbf{3 0}$ | $\mathbf{1 1}$ | $\mathbf{4 0}$ | $\mathbf{4 4}$ |

Note：reference voltage $=-100 \mathrm{mV}$ ．
Voltge＋PEAK：

| CR（times／sec） | ZI（ms） | AZ（ms） | INT（ms） | DINT（ms） |
| :---: | :---: | :---: | :---: | :---: |
| $\mathbf{8}$ | $\mathbf{3 0}$ | $\mathbf{1 1}$ | $\mathbf{4 0}$ | $\mathbf{6 0}$ |

Note：reference voltage $=-100 \mathrm{mV}$ ．

## 2．Component Value Selection for ADC

For various application requirements on conversion rate and input full range，we suggest nominal values for external components of ADC in Figure 1 to obtain better performance．Under default condition with operating clock $=12 \mathrm{MHz}$ ：
（1）conversion rate $=8$ times $/ \mathrm{sec}$
（2）reference voltage $=-100 \mathrm{mV}$
（3）input signal full scale $=110 \mathrm{mV}($ sensitivity $=10 \mathrm{uV})$
We suggest that Cint $=68 \mathrm{nF}, \mathrm{Buf}=56 \mathrm{k} \Omega$
If a user selects a different conversion rate rather than default，the integration capacitor Cint value must be changed according to the following rule for better performance：

Cint $\times($ conversion rate $)=(68 \mathrm{nF}) \times(8$ times $/ \mathrm{sec})$.
A smaller Cint reduces the input full range．However a larger Cint might have weaker noise immunity than the suggested one．

A user could enlarge the input full range by changing reference voltage（Vref）and the amount of integration resistor（Buf）．For example，if Vref \＆Buf are enlarged as twice than the default values then the input full range becomes 220 mV ．The input full range can be enlarged up to 1.1 V （ 10 times than the default case）．We list general rules in below which might be helpful in determining component values．

Buf $/($ reference voltage $)=56 \mathrm{k} \Omega /(-100 \mathrm{mV})$

## 3．Multi Channel Input

ES51993 provides VIN＋，VIN1＋，VIN2＋and Vin－pins to achieve the multi channel input（multiplexer）feature．Because ES51993 is a single core A－to－D converter，it can only process one pack of data per conversion period．Although it has four input pins，it would take only one pair as input channel from the four pins．The actual input channel is determined by the bits $\mathrm{CH} 1 / \mathrm{CH} 0$ of STATUS Byte 1 as the following table：

| Input Channel | CH1 | CH0 | High Input | Low Input |
| :---: | :---: | :---: | :---: | :---: |
| ch1 | 0 | 0 | VIN＋ | VIN－ |
| ch2 | 0 | 1 | VIN1＋ | VIN－ |
| ch3 | 1 | 0 | VIN2＋ | VIN－ |
| ch4 | 1 | 1 | VIN2＋ | VIN1＋ |

ES51993 also configures an input channel rotation（polling）feature．Setting the ROT bit of STATUS Byte2 to high can activate the rotation feature．In the rotation mode，the actual input channel will be changed by ES51993 sequentially and automatically．The rotation feature has two types，one is for three input channel rotation with the same low input，another one is for two independent differential channel rotation．The following table presents the configuration of the rotation type．

Rotation Type Table：

| ROT | CH1，CH0 | Rotation Type |
| :---: | :---: | :---: |
| H | 0,0 |  |
|  | 0,1 | $\operatorname{ch} 1 \rightarrow \operatorname{ch} 2 \rightarrow \operatorname{ch} 3 \rightarrow \operatorname{ch} 1 \cdots$ |
|  | 1,0 |  |
|  | 1,1 | ch1 $\rightarrow$ ch4 $\rightarrow$ ch1 $\cdots$ |
| L | - | Not Rotating |

## 4．Special function

## 4．1 Peak Hold

ES51993 provide a Peak Hold function to capture the REAL peak value for voltage or current measurement mode．In a case of a 1 V sine wave input voltage，the Peak Hold function gets a PMAX value of 1.414 V and PMIN value of -1.414 V ．Set the bit PEAK of STATUS byte3 to high to force the ES51993 enter PEAK mode．．In the PEAK mode， ES51993 takes high input from PHin and low input from AGND．Peak Hold function is divided into two parts of peak maximum and peak minimum conversion．ES51993 performs peak maximum and peak minimum conversion by turns，not at the same time． The bit PMAX and PMIN of STATUS Byte2 present which type the peak value is．

## 4．2 Peak Calibration

In PEAK mode，the offset voltage of internal OP Amps will cause an error．To obtain a more accurate value，this offset effect must be canceled．ES51993 provides the Peak Calibration feature to remove the influence on accuracy by internal offset voltage．Set the bit PCAL of STATUS Byte2 to high to enter Peak Calibration mode．In this mode， ES51993 will output the calibration value of peak maximum and minimum conversion by turns．The calibration value is the error rise from offset voltage，and it muse be recorded．In PEAK mode，the peak value must minus the calibration value to remove the error．

## Note：

1．After entering Peak or PCAL mode，it is recommended to leave the Peak or PCAL mode first．Then wait one conversion time delay before change mode to PCAL or Peak mode，respectively．The time delay is necessary for normalizing the charge of $\mathrm{P}_{\mathrm{MAX}} / \mathrm{P}_{\mathrm{MIN}}$ capacitor．
2．When buzzer control bit is active，the Peak \＆PCAL mode are not allowed．

## 4．3 Zero and RZero Calibration

The Zero and RZero calibration are designed for removing the error rise from the propagation delay of internal component．In Zero or RZero calibration mode，ES51993 outputs a calibration value．The normal measurement value must minus the calibration value to cancel the error and obtain a more accurate value．The following block diagram performs the difference between basic structures of normal mode，Zero calibration and RZero Calibration．We suggest users to do zero－calibration in most applications．

（a）Normal mode

（b）Zero mode

（c）RZero mode

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## 4．4 Buzzer Setup

When the bit BUZ of ID Byte is set to＂H＂，the BUZOUT will output a square signal of MPU I／O swing level to drive a external buzzer．The buzzer frequency is determined by the bits $\mathrm{B} 0 / \mathrm{B} 1 / \mathrm{B} 2$ of STATUS Byte3．The configuration of buzzer frequency is listed at the following table．

| B2／B1／B0 | BUZout（kHz） |
| :---: | :---: |
| 111 | 4.00 |
| 110 | 3.33 |
| 101 | 3.08 |
| 100 | 2.67 |
| 011 | 2.22 |
| 010 | 2.00 |
| 001 | 1.33 |
| 000 | 1.00 |

## 4．5 Low Battery Detection

In a case of 3 V battery power，the pin LBAT must be shorted to AGND．And the system will have low battery detection level about 2.3 V ．In another case of 9 V or other battery power，the low battery detection happens when the voltage of LBAT is less than -1.23 V below GND．And the bit LBAT of STATUS Byte3 will be set to high．A recommended application is shown as following：

Low battery test（9V）


The low battery detection level is around 7 V

## 4．6 Sleep Mode

When the pin CS is connected to V－or GND（depended on I／O＿control level），the ES51993 will enter sleep mode．In Sleep mode，the chip draws a little supply current．It could extend the battery life．To leave sleep mode or stay in normal mode，the pin CS must be connected to AGND or floating．

## 5．MPU I／O functional definition

## Write command：

ID byte，Status byte1，Status byte2，Status byte3
START BIT


## Read command：

ID byte，Status byte1，Status byte2，Status byte3，Data byte1，Data byte2


Start and Stop bit


ID byte：

| $\mathbf{1}$ | $\mathbf{1}$ | $\mathbf{0}$ | $\mathbf{0}$ | $\mathbf{0}$ | $\mathbf{1}$ | $\mathbf{B U Z}$ | $\mathbf{R} / \mathbf{W}$ |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

Status byte1：

| CH0 | CH1 | C0 | C1 | C2 | SIGN | SEL4M | X |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

Status byte2：

| S60 | RZERO | ZERO | ROT | PMAX | PMIN | X | X |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |

Status byte3：

| PEAK | PCAL | B0 | B1 | B2 | LBAT | X | X |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |

Data byte1：

| D0 | D1 | D2 | D3 | D4 | D5 | D6 | D7 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

Data byte2：

| D8 | D9 | D10 | D11 | D12 | D13 | X | X |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

$\mathbf{R} / \mathbf{W}$ ：set to＂ H ＂is in read mode，set to＂ L ＂is in write mode
$\mathbf{C H 1 / C H 0}$ ：ADC input channel selection，the default is［00］．

| Code | VIN $(+)$ | VIN（－） |
| :---: | :---: | :---: |
| 00 | VIN0 channel | VIN－channel |
| 01 | VIN1 channel | VIN－channel |
| 10 | VIN2 channel | VIN－channel |
| 11 | VIN2 channel | VIN1 channel |

$\mathbf{C 2} / \mathbf{C 1} / \mathbf{C 0} / \mathbf{S 6 0}$ ：Conversion rate selection，the default is［0000］

| $\mathrm{C} 2 / \mathrm{C} 1 / \mathrm{C} 0$ | S 60 |  |
| :---: | :---: | :---: |
|  | L | H |
| 101 | $128 / \mathrm{s}$ | $128 / \mathrm{s}$ |
| 100 | $96 / \mathrm{s}$ | $96 / \mathrm{s}$ |
| 011 | $64 / \mathrm{s}$ | $76.8 / \mathrm{s}$ |
| 010 | $32 / \mathrm{s}$ | $38.4 / \mathrm{s}$ |
| 001 | $16 / \mathrm{s}^{!}$ | $19.2 / \mathrm{s}^{*}$ |
| 000 | $8 / \mathrm{s}^{!}$ | $9.6 / \mathrm{s}^{*}$ |
| 110 | $3.2 / \mathrm{s}^{!*}$ | $3.84 / \mathrm{s}^{*}$ |
| 111 | $1.6 / \mathrm{s}^{!*}$ | $1.92 / \mathrm{s}^{*}$ |

Crystal： 12 MHz
！： 50 Hz line noise rejection，$*: 60 \mathrm{~Hz}$ line noise rejection
SEL4M：＂H＂is XTAL is 4 MHz version，＂L＂is default 12 MHz XTAL

| $\mathrm{C} 2 / \mathrm{C} 1 / \mathrm{C} 0$ | S 60 |
| :---: | :---: |
|  | X |
| 101 | $128 / \mathrm{s}$ |
| 100 | $64 / \mathrm{s}$ |
| 011 | $64 / \mathrm{s}$ |
| 010 | $32 / \mathrm{s}$ |
| 001 | $16 / \mathrm{s}^{!}$ |
| 000 | $8 / \mathrm{s}^{!}$ |
| 110 | $3.2 / \mathrm{s}^{!^{*}}$ |
| 111 | $1.6 / \mathrm{s}^{!^{*}}$ |

Crystal ：4MHz
SIGN：＂H＂is negative，＂L＂is positive
PMAX：＂$H$＂is maximum peak value，the default is＂L＂
PMIN：＂ H ＂is minimum peak value，the default is＂$L$＂
LBAT：＂H＂is low battery detection flag active，the default is＂L＂
PEAK：＂$H$＂is peak hold function turn on，the default is＂L＂
PCAL：＂H＂is peak hold function calibration mode is active，the default is＂L＂
RZERO：＂H＂is RZero calibration mode＂ON＂，the default is＂L＂

ZERO：＂H＂is Zero calibration mode＂ON＂，the default is＂L＂
ROT：Set to＂H＂to enable multi channel rotating feature
B2／B1／B0：Buzzer frequency selection（independent with conversion rate）
BUZ：＂H＂is buzzer turn on and＂L＂is turn off，the default is turn off．

## Buzzer ON

START BIT


STOP BIT

## Buzzer OFF

START BIT


STOP BIT
D13－D0：ADC output data according channel multiplex［CH1／CH0］．Binary code format．

## 6．Power and I／O output level selection

## Power

－Charge pump output for positive supply voltage（ $\mathrm{V}+$ ）
－External DC source to $\mathrm{V}+$ is available by floating the charge pump capacitor

## I／O output level selectable

－uP＿VCC provided by external DC source（the same high level with MPU）
－A control pin（I／O＿control）selects the low level to $-3 \mathrm{~V}(\mathrm{~V}-)$ or $0 \mathrm{~V}(\mathrm{DGND})$

| uP＿VCC | $\mathrm{I} / \mathrm{O}_{-}$control | $\mathrm{I} / \mathrm{O}$ level |  | Example |
| :---: | :---: | :---: | :---: | :---: |
|  |  | H | L |  |
| 3 | H | +3 V | 0 V | Ex．1 |
| 3 | L | +3 V | -3 V | Ex．2 |
| 0 | L | 0 V | -3 V | Ex．3 |

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## Ex． 1



Ex． 2


Ex． 3

## Absolute Maximum Ratings

| Characteristic | Rating |
| :--- | :--- |
| Supply Voltage（V－to AGND） | -3.6 V |
| Analog Input Voltage | $\mathrm{V}--0.6$ to $\mathrm{V}++0.6$ |
| V＋ | $\mathrm{V}+\geq(\mathrm{AGND} / \mathrm{DGND}+0.5 \mathrm{~V})$ |
| AGND／DGND | AGND／DGND $\geq(\mathrm{V}--0.5 \mathrm{~V})$ |
| Digital Input | $\mathrm{V}--0.6$ to DGND +0.6 or $\mathrm{V}++0.6$ |
| Power Dissipation．Flat Package | 500 mW |
| Operating Temperature | $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ |
| Storage Temperature | $-25^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ |

## DC Electrical Characteristics

| Parameter | Symbol | Test Condition | Min． | Typ． | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Power supply | V－ |  | －3．3 | －3．0 | －2．5 | V |
| Operating supply current Conversion rate $=8 / \mathrm{sec}$ ． | $\mathrm{I}_{\mathrm{DD}}$ | Normal operation （XTAL＝12MHz） | － | 2.0 | 2.2 | mA |
|  | $\mathrm{I}_{\text {SS }}$ | In sleep mode | － | 2.5 | 5 | $\mu \mathrm{A}$ |
| Voltage roll－over error | REV |  | － | － | $\pm 0.05$ | \％F．S ${ }^{1}$ |
| Voltage nonlinearity | NLV | Best case straight line | － | － | $\pm 0.05$ | \％F．S |
| Input Leakage |  |  |  | 1 | 10 | pA |
| Low battery flag voltage |  | V－to AGND | －2．4 | －2．3 | －2．2 | V |
| Internal pull－high to uP＿Vcc current |  | CS（uP Vcc＝3V） |  | 5 |  | uA |
|  |  | CS（uP＿Vcc＝0V） |  | 1.5 |  |  |
| Internal pull－low to V－current |  | $\begin{aligned} & \mathrm{I} / \mathrm{O} \text { control } \\ & (\mathrm{V}-=-3 \mathrm{~V}) \\ & \hline \end{aligned}$ |  | 1.5 |  | uA |
| Zero input reading |  | $10 \mathrm{M} \Omega$ input resistor zero cal．by MPU | －000 | 000 | $+000$ | counts |
| Reference voltage and open circuit voltage for $110 \Omega$ measurement | $\mathrm{V}_{\text {ReF }}$ | $100 \mathrm{~K} \Omega$ resistor between VRH and AGND | －1．33 | －1．23 | －1．13 | V |
| Reference voltage temperature coefficient | $\mathrm{TC}_{\mathrm{RF}}$ | $100 \mathrm{~K} \Omega$ resister Between VRH $0^{\circ} \mathrm{C}<\mathrm{TA}<70^{\circ} \mathrm{C}$ | － | 50 | － | ppm／$/{ }^{\circ} \mathrm{C}$ |
| Minimum pulse width for Peak Hold feature | $\mathrm{T}_{\mathrm{PW}}$ |  | 100 |  |  | $\mu \mathrm{s}$ |

Note：
1．Full Scale

AC Electrical Characteristics

| Parameter | Symbol | Min． | Typ． | Max． | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| SCLK clock frequency | $\mathrm{f}_{\text {SCLK }}$ | － | － | 100 | kHz |
| SCLK clock time＂L＂ | $\mathrm{t}_{\text {Low }}$ | 4.7 | － | － | us |
| SLCK clock time＂H＂ | $\mathrm{t}_{\mathrm{HIGH}}$ | 4.0 | － | － |  |
| SDATA output delay time | $\mathrm{t}_{\mathrm{AA}}$ | 0.1 | － | 3.5 |  |
| SDATA output hold time | $\mathrm{t}_{\mathrm{DH}}$ | 100 | － | － | ns |
| Start condition setup time | $\mathrm{t}_{\text {SU．STA }}$ | 4.7 | － | － | us |
| Start condition hold time | $\mathrm{t}_{\text {HD．STA }}$ | 4.0 | － | － |  |
| Data input setup time | $\mathrm{t}_{\text {SU．DAT }}$ | 200 | － | － | ns |
| Data input hold time | $\mathrm{t}_{\text {HD．DAT }}$ | 0 | － | － |  |
| Stop condition setup time | $\mathrm{t}_{\text {SU．STO }}$ | 4.7 | － | － | us |
| SCLK／SDATA rising time | $\mathrm{t}_{\mathrm{R}}$ | － | － | 1.0 |  |
| SCLK／SDATA falling time | $\mathrm{t}_{\mathrm{F}}$ | － | － | 0.3 |  |
| Bus release time | $\mathrm{t}_{\text {BUF }}$ | 4.7 | － | － |  |
| EOC setup time in read mode | $\mathrm{t}_{\text {SU．EOC }}$ | 0 |  |  | ns |
| EOC hold time in read mode | $\mathrm{t}_{\text {HD．EOC }}$ | 0 | － | － | ns |

## I／O timing diagram



## Read mode EOC timing diagram



## Application example



Note：
Zener diodes in above circuit are used for IC protection，so MUST be soldered on PCB first．
＊1＊2＊3＊4：Depend on power design
＊＊Depends on conversion rates setting： $\mathrm{V}-\mathbf{= - 3 . 0 V}$

| （a）Conversion rate | $(\mathrm{b}) \mathrm{C}_{\mathrm{INT}}(\mathrm{uF})$ | $(\mathrm{c}) \mathrm{R}_{\mathrm{BUF}}(\mathrm{k} \Omega)$ | （a）Conversion rate | $(\mathrm{b}) \mathrm{C}_{\mathrm{INT}}(\mathrm{uF})$ | $(\mathrm{c}) \mathrm{R}_{\mathrm{BUF}}(\mathrm{k} \Omega)$ |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $128 / \mathrm{s}$ | 0.01 | 22 | $16 / \mathrm{s}$ | 0.068 | 27 |
| $96 / \mathrm{s}$ | 0.01 | 30 | $9.6 / \mathrm{s}$ | 0.047 | 68 |
| $76.8 / \mathrm{s}$ | 0.01 | 39 | $8 / \mathrm{s}$ | 0.068 | 56 |
| $64 / \mathrm{s}$ | 0.022 | 22 | $3.84 / \mathrm{s}$ | 0.1 | 82 |
| $38.4 / \mathrm{s}$ | 0.022 | 36 | $3.2 / \mathrm{s}$ | 0.1 | 91 |
| $32 / \mathrm{s}$ | 0.033 | 27 | $1.92 / \mathrm{s}$ | 0.22 | 68 |
| $19.2 / \mathrm{s}$ | 0.033 | 47 | $1.6 / \mathrm{s}$ | 0.22 | 91 |

＊＊＊ $\mathbf{R}=\mathbf{1 0} \sim \mathbf{2 2 M} \Omega$ resistor is optional

Product Outline：LQFP－32


VARIATIONS（ALL DINENSIONS SHOWN IN MM）

| SYMBOLS | MIN． | MAX． |
| :---: | :---: | :---: |
| A | -- | 1.6 |
| A1 | 0.05 | 0.15 |
| A2 | 1.35 | 1.45 |
| c1 | 0.09 | 0.16 |
| D | 9.00 BSC |  |
| D1 | $7.00 \mathrm{B5C}$ |  |
| E | 9.00 B5C |  |
| E1 | 7.00 BSC |  |
| e | 0.8 BSC |  |
| b | 0.30 | 0.45 |
| L | 0.45 | 0.75 |
| L1 | 1 REF |  |

NOTES：
1．JEDEC OUTLINE：MS－026 日EA
2．DIMENSIDNS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION．ALLOWABLE PROTRUSION IS 0.25 mm PER SIDE．D1 AND E1 ARE MAXIMUM PLASTIC BODY SIZE DIMENSIONS IMCLUDING MOLD MISMATCH．
3．DIMENSIDN b DOES NDT INCLUDE DAMBAR PROTRUSION．ALLOWAGLE DAMBAR PROTRUSION
SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED THE MAXIMUM b DIMENSION BY MORE THAN 0.08 mm ．

